



2N7002

N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
60V	5Ω @ V _{GS} = 10V	210mA
	7.5Ω @ V _{GS} = 5V	170mA

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- · Fast Switching Speed
- Small Surface-Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

 An automotive-compliant part is available under separate datasheet (2N7002Q)

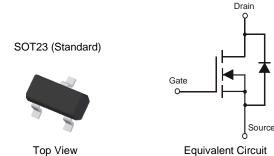
Description and Applications

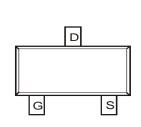
This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Motor controls
- Power-management functions

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram
- Weight: 0.009 grams (Approximate)





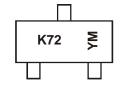
Top View

Ordering Information (Note 4)

Part Number	Paskaga	Packing		
Fait Number	Package	Qty.	Carrier	
2N7002-7-F	SOT23 (Standard)	3,000	Tape & Reel	
2N7002-13-F	SOT23 (Standard)	10,000	Tape & Reel	

- Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 - 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



K72 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} or \underline{Y} = Year (ex: L = 2024) M or \overline{M} = Month (ex: 9 = September)

Date Code Key

Year	2002	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	N	-	L	М	N	Р	R	S	T	U	V	W
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	4	2	2	1		6	7	0	0		NI	ר



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	60	V
Drain-Gate Voltage R _{GS} ≤ 1.0MΩ			Vdgr	60	V
Gate-Source Voltage	Continuous Pulsed (Note 8)	VGSS	±20 ±40	V	
Continuous Drain Current (Note 5) Vgs = 10V	Steady State	T _A = +25°C T _A = +85°C T _A = +100°C	lo	170 120 105	mA
Continuous Drain Current (Note 6) VGS = 10V	Steady State	T _A = +25°C T _A = +85°C T _A = +100°C	lo	210 150 135	mA
Maximum Continuous Body Diode Forward Curre	Continuous Pulsed (Note 8)	Is	0.2 0.5	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)		I _{DM}	800	mA

Thermal Characteristics (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation	(Note 5)	Pp	370	mW	
Total Power Dissipation	(Note 6)	PD	540		
Thermal Designation to Ambient	(Note 5)	,	348	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	Reja	241		
Thermal Resistance, Junction to Case	(Note 6)	R ₀ JC	91		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

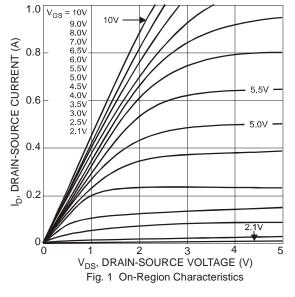
Electrical Characteristics (@ TA = +25°C, unless otherwise specified.)

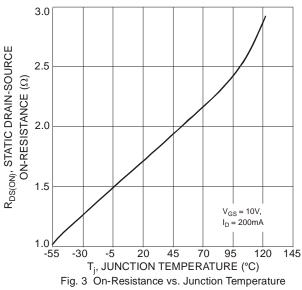
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage		BVDSS	60	70	_	V	$V_{GS} = 0V, I_{D} = 10\mu A$
Zero Gate Voltage Drain Current	Zero Gate Voltage Drain Current @ $T_J = +25^{\circ}C$ @ $T_J = +125^{\circ}C$			_	1.0 500	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Body Leakage		I _{GSS}	_	_	±10	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage		Vgs(TH)	1.0	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	@ T _J = +25°C @ T _J = +25°C @ T _J = +125°C	RDS(ON)		3.2 2.4 4.4	7.5 5.0 13.5	Ω	$V_{GS} = 5.0V$, $I_D = 0.05A$ $V_{GS} = 10V$, $I_D = 0.5A$ $V_{GS} = 10V$, $I_D = 0.5A$
On-State Drain Current		I _D (ON)	0.5	1.0	_	Α	$V_{GS} = 10V, V_{DS} = 7.5V$
Forward Transconductance	Forward Transconductance		80	_	_	mS	$V_{DS} = 10V, I_{D} = 0.2A$
Diode Forward Voltage	V _{SD}		0.78	1.5	V	V _G S = 0V, I _S = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance		Ciss		22	50	pF	V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz
Output Capacitance		Coss		11	25	pF	
Reverse Transfer Capacitance		C _{rss}		2.0	5.0	pF	T = 1.0IVII IZ
Gate Resistance		Rg	_	120	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$ f = 1.0MHz
Total Gate Charge (V _{GS} = 4.5V)		Qg		223	_		
Gate-Source Charge		Qgs		82	_	рC	$V_{DS} = 10V, I_{D} = 250mA$
Gate-Drain Charge		Q_{gd}		178	_		
Turn-On Delay Time	t _D (ON)	_	2.8	_		.,	
Turn-On Rise Time		tR		3.0	_	no	$V_{DD} = 30V, I_D = 0.2A$
Turn-Off Delay Time		t _{D(OFF)}		7.6	_	ns	$R_L = 150\Omega$, $V_{GEN} = 10V$ $R_{GEN} = 25\Omega$
Turn-Off Fall Time		tF		5.6	_		11GEN - 2012

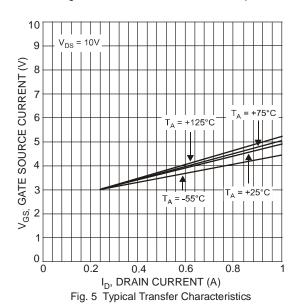
Notes:

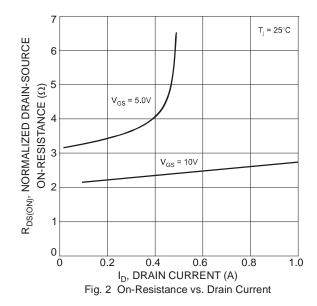
- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. copper, single sided.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

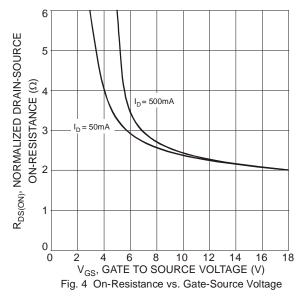












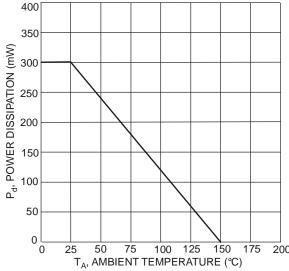


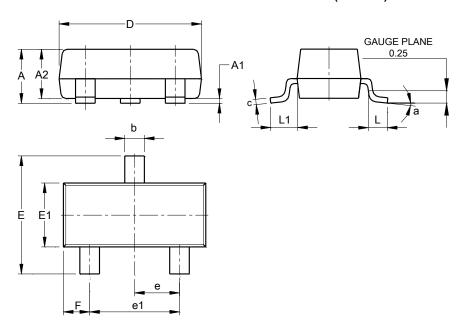
Fig. 6 Max Power Dissipation vs. Ambient Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23 (Standard)

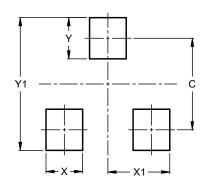


SOT23 (Standard)						
Dim	Min	Max	Тур			
Α	0.90	1.15	1.025			
A1	0.00	0.10	0.05			
A2	0.85	1.10	0.975			
b	0.30	0.51	0.40			
С	0.080	0.202	0.11			
D	2.80	3.00	2.90			
E	2.25	2.55	2.40			
E1	1.20	1.40	1.30			
е	0.89	1.03	0.915			
e1	1.78	2.05	1.83			
F	0.40	0.60	0.535			
L1	0.45	0.61	0.55			
L	0.25	0.55	0.40			
а	0°	8°				
All	Dimens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23 (Standard)



Dimensions	Value (in mm)
С	2.0
X	0.8
X1	1.35
Y	0.9
V1	2.0



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2N7002 5 of 5 July 2024

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